



Features:

Compatible with automatic placement equipment

Compatible with reflow solder process

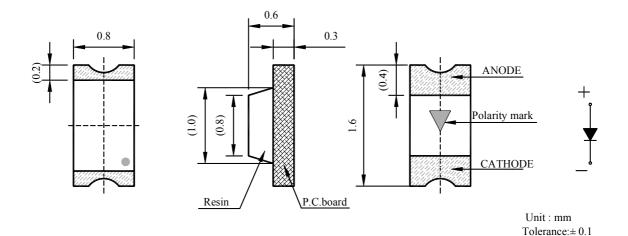
Low power consumption and wide viewing angle

This product doesn't contain restriction Substance, comply ROHS standard.

Applications:

Automotive and Telecommunication Flat backlight for LCD ,switch and symbol in telephone and fax General use for indicators

Package Dimensions:



Electrodes: Au Plating

Encapsulating Resin: Epoxy Resin

Package: BT Resin

Part No.	0603-FLWC-HY					
Emitted Color	Yellow Green	Len's Color	Water Clear			
Chip Material	AlGaInP					





Absolute Maximum Rating (Ta=25°C)

Parameter	Symbol	Max.	Unit
Power Dissipation	P_D	60	mW
Pulse Forward Current	I_{FP}	60	mA
DC Forward Current	I_{F}	20	mA
Reverse Voltage	V_R	5	V
Operating Temperature Range	Topr	-40 ~ 85	
Storage Temperature Range	Tstg	-40 ~ 100	

^{*} I_{FP} condition: pulse width $\leq 1 \text{ms}$, duty cycle $\leq 1/10$

Electrical Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min	Тур.	Max.	Unit	Test Condition
Luminous Intensity	I_{V}	20	30		mcd	$I_F = 15 \text{mA}$
Forward Voltage	V_{F}		2.0		V	$I_F = 15 \text{ mA}$
Reverse Current	I_R			10	Ua	V _R =5V
Dominant Wavelength	λd	568	570		nm	I _F =15 mA
Spectral Line Half Width	Δλ		30		nm	I _F =15 mA
Viewing Angle	2θ 1/2		120		Deg.	$I_F = 15 \text{ mA}$

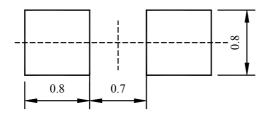
Notes: 1.Tolerance of Luminous Intensity ± 10%

- 2. Tolerance of Dominant Wavelength ± 2nm
- 3. Tolerance of Forward Voltage ± 0.05 V
- 4. Luminous Intensity is measured on bare chips



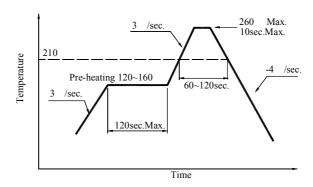


Soldering Pad Dimensions:



$Soldering Conditions \,\,(\,Maximum\,\,allowable\,\,soldering\,\,conditions\,\,)$

Reflow soldering profile <Pb-free solder>

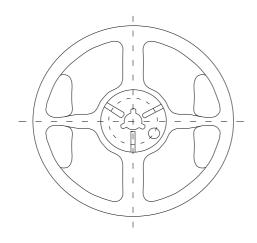


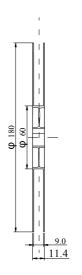
- Reflow soldering should not be done more than two times.
- Do not stress its resin while soldering.
- After soldering, do not warp the circuit board.

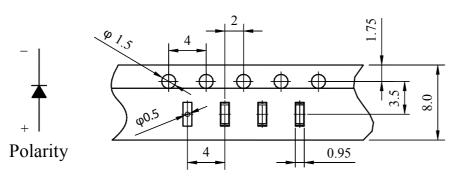


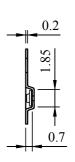


Package Tape Specifications: (4000 or 2000 pcs/Reel)

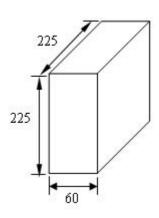




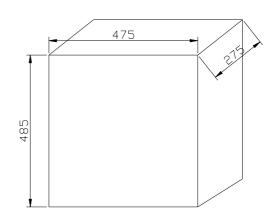




Reel Lead Min.60mm No LEDs



5 Reels in one Box

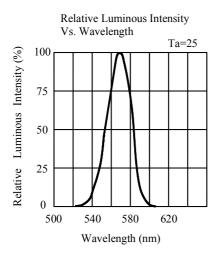


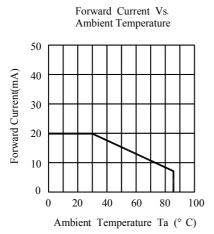
16 Boxes in one Carton

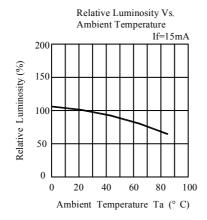


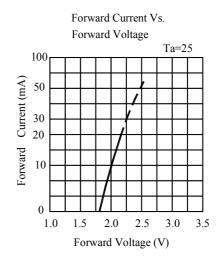


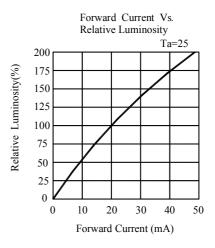
Typical ElectroOptical Characteristics Curves:

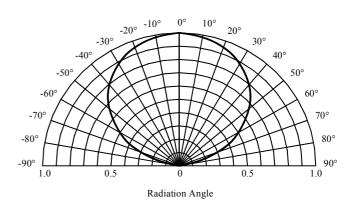
















Reliability

(1) Test Items and Conditions

NO	Test Item	Test Conditions	Sample	Ac/ Re
1	Temperature Cycle	le $ \begin{array}{c} -40\pm5^{\circ}\text{C} \rightarrow 25\pm5^{\circ}\text{C} \rightarrow 100\pm5^{\circ}\text{C} \rightarrow 25\pm5^{\circ}\text{C} \\ (30\text{min}, 5\text{min}, 30\text{min}, 5\text{min}) 100 \text{ Cycles} \end{array} $		0/1
2	High Temperature Storage Ta: 100±5°C Test time=1000HRS(-24HRS,+72HRS)		20	0/1
3	High Temperature And High Humidity Storage	Ta: 85±5°C, R _H :85±5%, Test time=500HRS(-24HRS,+72HRS)	20	0/1
4	Low Temperature Storage Ta: -40±5°C Test time=1000HRS(-24HRS,+72HRS)		20	0/1
5	Operating Life Test	Connect with a power I _F =15mA Ta=Under room temperature Test time=1000HRS(-24HRS,+72HRS)	20	0/1
6	Thermal Shock $ \begin{array}{c} -40\pm5^{\circ}\text{C} \rightarrow 100\pm5^{\circ}\text{C} \\ (15\text{min}, 15\text{min}) \ 100 \ \text{Cycles} \end{array} $		20	0/1
7	IR-Reflow Pb-Free Process	①80°C②100°C③120°C④160°C⑤170 °C⑥235°C⑦270°C⑧255°C, 60cm/min, 2 times	20	0/1

(2)Criteria of judging the damage

Item	Crymh al	Test condition	Criteria for judgement			
Item	Symbol	rest condition	Min.	Max.		
Forward voltage	V_{F}	I _F =Test Current	/	U.S.L*1.1		
Reverse current	I_R	V _R =5V	/	15uA		
Luminous intensity	I_V	I _F =Test Current	L.S.L*0.7	/		
Wave length	λ D/ λ Ρ	I _F =Test Current	/	U.S.L±2nm		
Appearance	/	View check	No mechanical damage			

^{*} U.S.L: Upper standard level

L.S.L: Lower standard level



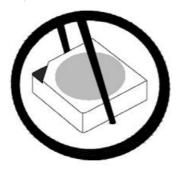


Storage and application notices

- 1. Before opening the package: the LEDs should be kept at 5-30°C and 60%RH or less; the LEDs should be used within three months;
- 2. LED SMD is a kind of semiconductor that is sensitive to the humility. So after opening the package, LED must be used within 24Hrs, or else should be kept at 5-30°C and 30%RH or less, and the LEDs should be used within 7days after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again. If the LEDs have exceeded the storage time, baking treatment should be performed more than 24Hs at 60°C±5°C.
- 3. The internal and esterand boxes can not be contacted with ground to prevent absorption of moisture;
- 4. No acid, alkali, salt, corrosive and explosive gas; away from sunlight and keep the environment clean;

2, Application

- 1. Do not use any unknown chemical liquid to clean LED, it will damage the LED resin surface; use the alcohol under the room temperature if necessary but less than 1 min, or use the ultrasonic cleaning with proper characters, such as correct power, frequency ,etc;
- 2. Do not touch the epoxy resin area when carrying LEDs by tweezers (as the following pictures), especially after the soldering process, the epoxy resin will turn to soft, the internal instruction will be damaged by the tweezers which cause the electric character's failure; nozzle is recommended by using SMT mounting.





Correct

Incorrect

3. Soldering iron: double-side soldering iron with power of less than 25W; soldering temperature: less than





300°C; soldering time: less than 3sec.; 1 time completed is recommended, if the 2nd soldering process is requested, 3mins must be left to ensure the high temperature status can return to room temperature;

- a. REFLOW soldering: set and test the temperature of the different area of REFLOW equipment in advance;
- b. To set the peak temperature according to different SMDs, but the actual peak temperature should be less than 260°C ,processing time should be less than 10sec, only 1 time is allowed;
- 4. SMDs should be soldered at the coordinated position on the PCB;
- 5. Note of Electrical matter:
 - ① One-way conduction, LED does not allow the reverse driving;
 - ② LED is a kind of constant current component which can not be lighted by the constant voltage mode; a smaller voltage fluctuation can cause the large current fluctuation which causes the failure of LED;
 - Each LED should be drove under constant current mode if in a parallel circuit design, otherwise, the colour and brightness will be nonuniform; When the environmental temperature rising, the LED junction temperature will rise, internal resistance will decrease, so the current will be increased by the constant voltage power which short the life span;
 - 3 If the brightness of lighting source can meet the requirement, we recommend using the driving current less than the rated current, in order to improve the product's reliability;
- 6. LED is a kind of electrostatic sensitive devises, anti-static measures have to be processed during storage and operation:
 - ① LED production workshop should lay anti-static floor and ground connection, the work table have to use the anti-static materials and cover a table mater with the surface resistance of 10^6 - $10^9\Omega$
 - 2 Production machine: REFLOW, SMT equipment, electric iron, test equipment; all the equipments must be well grounded, and the grounding alternating current impedance should be less than 1.0Ω . A fan need to be installed on the equipments and production processes that easy to generate static electricity; the operators must wear anti-static clothing, shoes, wristband, and gloves, etc. in the process;
 - 3 LEDs must be contained in the anti-static box, and all the package material should be the anti-static materials;
- 7. The details electronic characters can refer to our product specification.





Notes:

	1、Above s	specific	cation m	nay be	changed	l withou	t notic	e. We wi	ll reserv	e authorit	y on	material	chai	nge
for above	specificati	ion.												
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2. When using this product, please observe the absolute maximum ratings and the instructions for the specification sheets. We assume no responsibility for any damage resulting from use of the product which does not comply with the instructions included in the specification sheets.